









- ► PLCC2 Top View
- ➤ 3528+Lens 3.6t Series
- ► Cool White (5700K)

NOW45S99BF (13" reel)
NOW45S99BFSR (7" reel)



# 3528+Lens Series





#### . Davida

**FEATURES:** 

- Package: PLCC2 SMT Package Black Body with Lens
- Forward Current: 20mAForward Voltage (typ.): 3.1V
- Luminous Intensity (typ.): 8500mcd@20mA
- Colour: Cool White
- CCT: 5700K
- Viewing angle: 30°
- Materials:
  - Die: InGaN
  - Resin: Epoxy (Water Clear)
  - L/F Finish: Ag Plated
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
  - CIE Chromaticity
- Soldering methods: Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 12mm tape with max.2000pcs/reel, ø330mm (13") or max.600pcs/reel ø180mm (7")

3528 + Lens Series

### **APPLICATIONS:**

- LED Display
- Indicator
- Traffic Display
- Decoration Lighting



### **CHARACTERISTICS:**

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current Duty 1/8@1KHz	I <sub>FP</sub>	125	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	I <sub>R</sub>	10	μΑ
Power Dissipation	P <sub>D</sub>	102	mW
Operating Temperature	T <sub>OPR</sub>	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

## Electrical & Optical Characteristics (Ta=25°C)

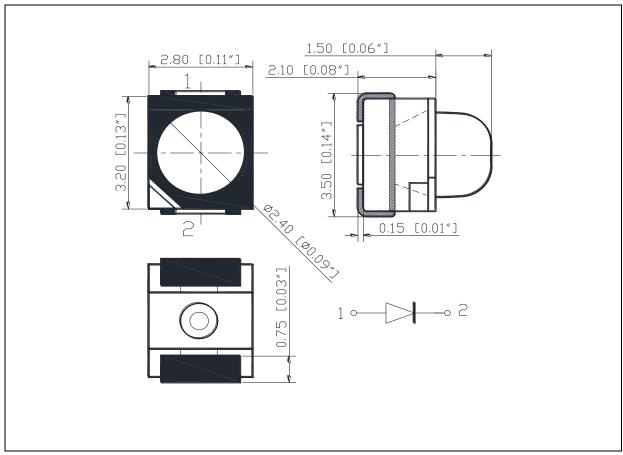
Parameter	Symbol	Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	2.8	3.1	3.4	V	I <sub>F</sub> =20mA
Luminous Intensity	Ιv	5000	8500	10000	mcd	I <sub>F</sub> =20mA
Luminous Flux	Ф۷		7.4		lm	I <sub>F</sub> =20mA
Chromaticity Coordinates	Х		0.3287			I <sub>F</sub> =20mA
	Υ		0.3417			
Colour Temperature	ССТ		5700		К	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		30		deg	I <sub>F</sub> =20mA

<sup>1.</sup> Luminous intensity (I<sub>v</sub>) ±15%, Forward Voltage (V<sub>F</sub>) ±0.1V, Viewing angle(2 $\theta_{1/2}$ ) ±5%



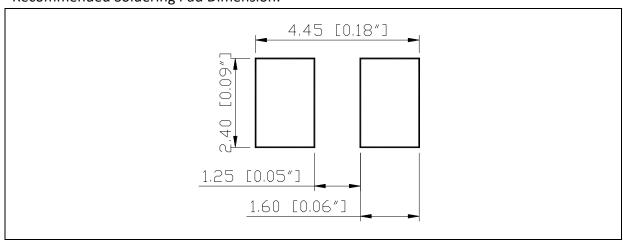
### **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

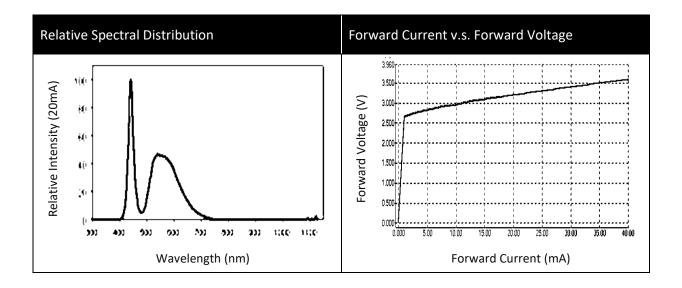
### **Recommended Soldering Pad Dimension:**

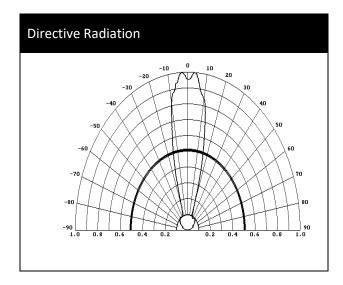


- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



## **ELECTRO-OPTICAL CHARACTERISTICS:**

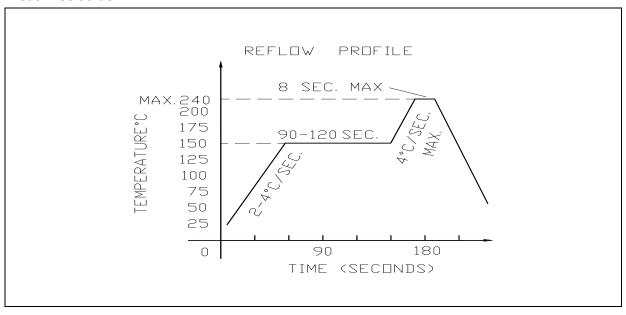






### **RECOMMENDED SOLDERING PROFILE:**

### Lead-free Solder:



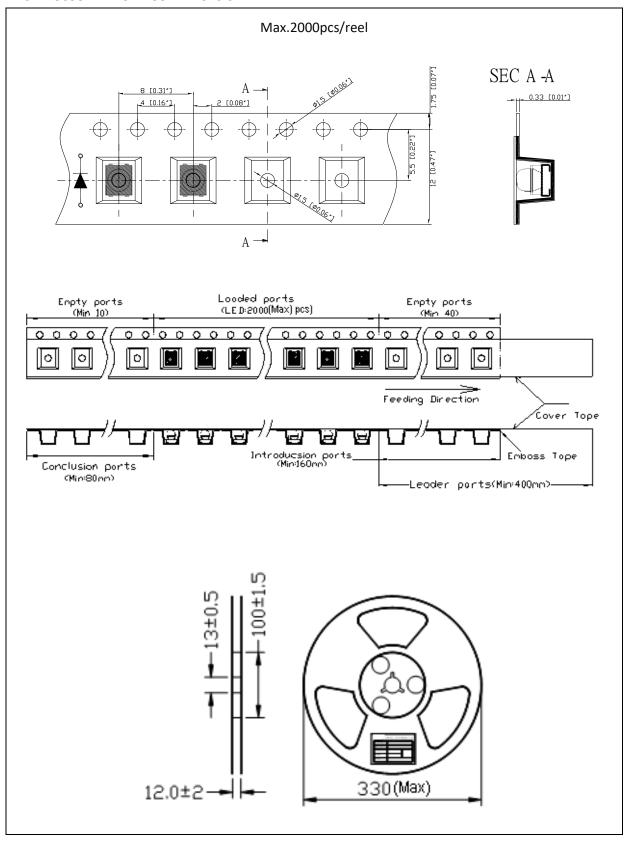
#### Note:

- 1. Maxima reflow soldering: 1 time.
- 2. The maxima soldering temperature is 240°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



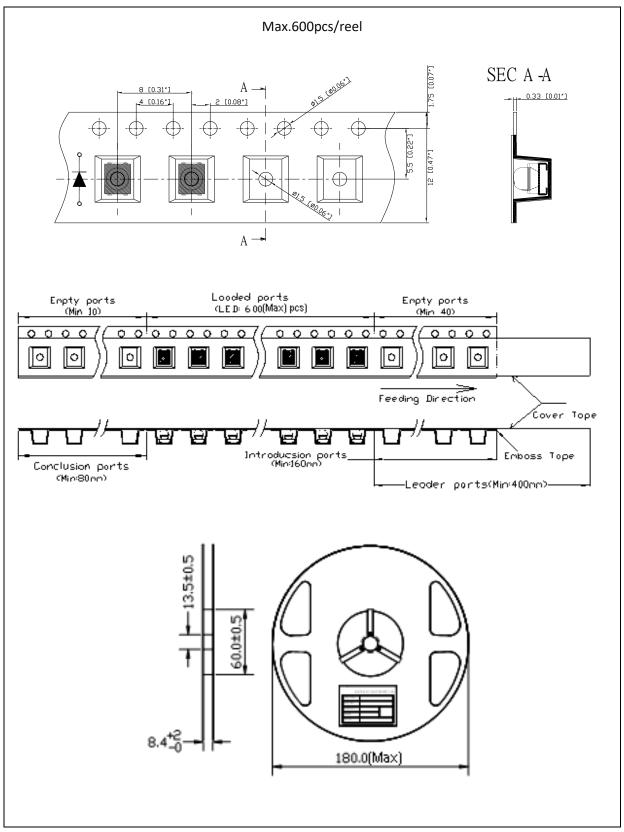
### **PACKING SPECIFICATION:**

### NOW45S99BF - 13" Reel Dimension:





### NOW45S99BFSR - 7" Reel Dimension:





#### **PRECAUTIONS OF USE:**

### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

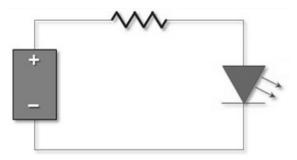
### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



## **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	06/08/2022	Datasheet set-up.